MOSFETs Silicon P-Channel MOS (U-MOSVI)

TJ8S06M3L

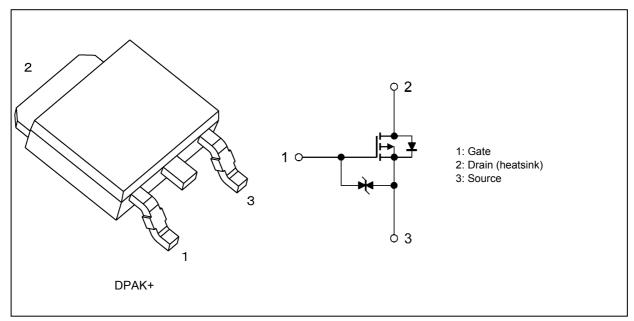
1. Applications

- Automotive
- Motor Drivers
- DC-DC Converters
- Switching Voltage Regulators

2. Features

- (1) AEC-Q101 qualified
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 80 \text{ m}\Omega$ (typ.) ($V_{GS} = -10 \text{ V}$)
- (3) Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -60 \ V)$
- (4) Enhancement mode: V_{th} = -2.0 to -3.0 V (V_{DS} = -10 V, I_D = -1 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics				Rating	Unit
Drain-source voltage			V _{DSS}	-60	V
Gate-source voltage			V _{GSS}	-20/+10	1
Drain current (DC)		(Note 1)	Ι _D	-8	Α
Drain current (pulsed)		(Note 1)	I _{DP}	-16]
Power dissipation	(T _c = 25°C)		PD	27	W
Single-pulse avalanche energy		(Note 2)	E _{AS}	19	mJ
Avalanche current			I _{AR}	-8	Α
Channel temperature		(Note 3)	T _{ch}	175	°C
Storage temperature		(Note 3)	T _{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	5.4	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: V_DD = -25 V, T_ch = 25°C (initial), L = 404 $\mu H, R_G$ = 25 Ω, I_{AR} = -8 A

Note 3: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

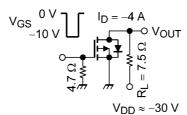
6.1. Static Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = -16/+10 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	—	—	-10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = -10 mA, V _{GS} = 0 V	-60	_	_	V
Drain-source breakdown voltage (Note 4)	V _{(BR)DSX}	I _D = -10 mA, V _{GS} = 10 V	-50	_	_	
Gate threshold voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-2.0	_	-3.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = -6 V, I _D = -4 A	—	90	130	mΩ
		V _{GS} = -10 V, I _D = -4 A	_	80	104	

Note 4: If a forward bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	890	_	pF
Reverse transfer capacitance	C _{rss}		_	60	—	
Output capacitance	C _{oss}		_	100	—	
Switching time (rise time)	tr	See Figure 6.2.1.	_	6	—	ns
Switching time (turn-on time)	t _{on}			14	—	
Switching time (fall time)	t _f		_	34	—	
Switching time (turn-off time)	t _{off}		_	140		



Duty \leq 1%, t_w = 10 µs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx$ -48 V, V_{GS} = -10 V, I_D = -8 A	—	19	—	nC
Gate-source charge	Q _{gs}		_	13.5	_	
Gate-drain charge	Q _{gd}			5.5		

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 5)	I _{DR}	—	_	_	-8	А
Reverse drain current (pulsed)	(Note 5)	I _{DRP}	—	_	_	-16	
Diode forward voltage		V _{DSF}	I _{DR} = -8 A, V _{GS} = 0 V	_	_	1.2	V
Reverse recovery time		t _{rr}	I _{DR} = -8 A, V _{GS} = 0 V	_	35		ns
Reverse recovery charge		Q _{rr}	dl _{DR} /dt = 50 A/µs	_	20	_	nC

Note 5: Ensure that the channel temperature does not exceed 175°C.

7. Marking (Note)

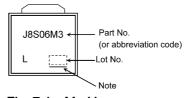
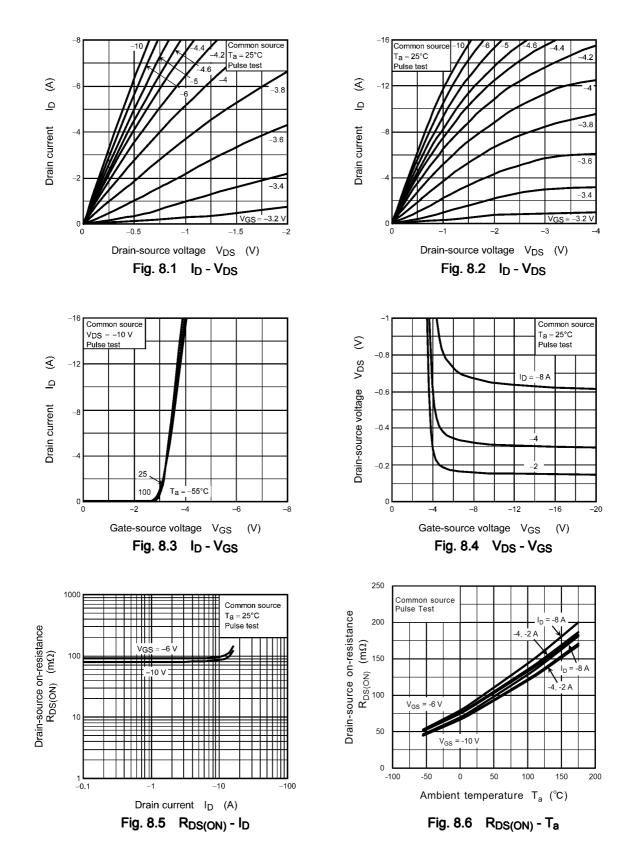


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)

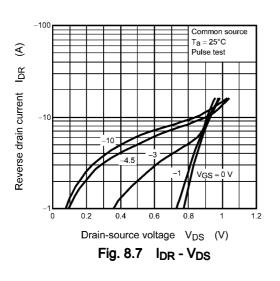


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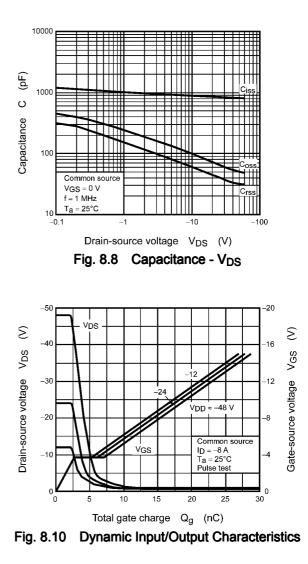
-3

-2



Common source VDS = -10 V ID = -1 mA

Pulse test



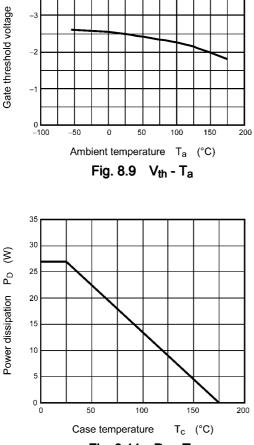
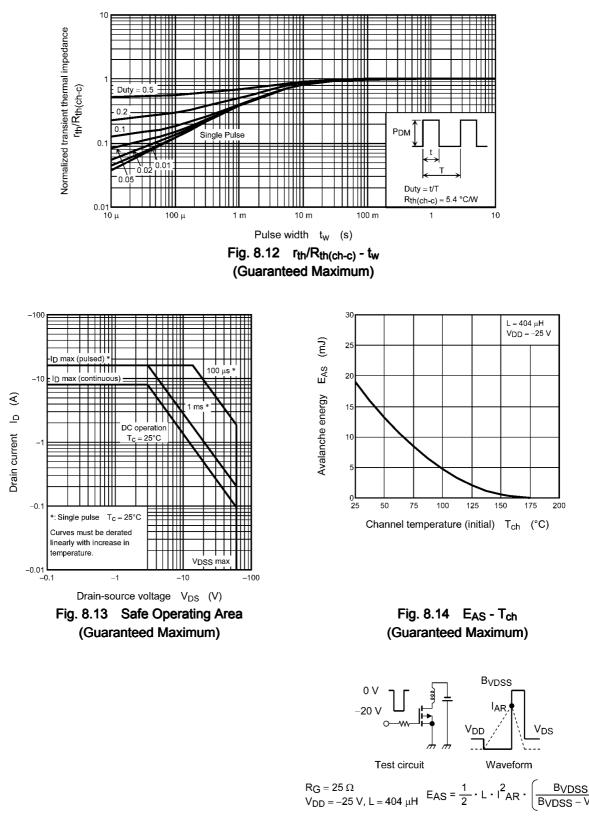


Fig. 8.11 P_D - T_c (Guaranteed Maximum)

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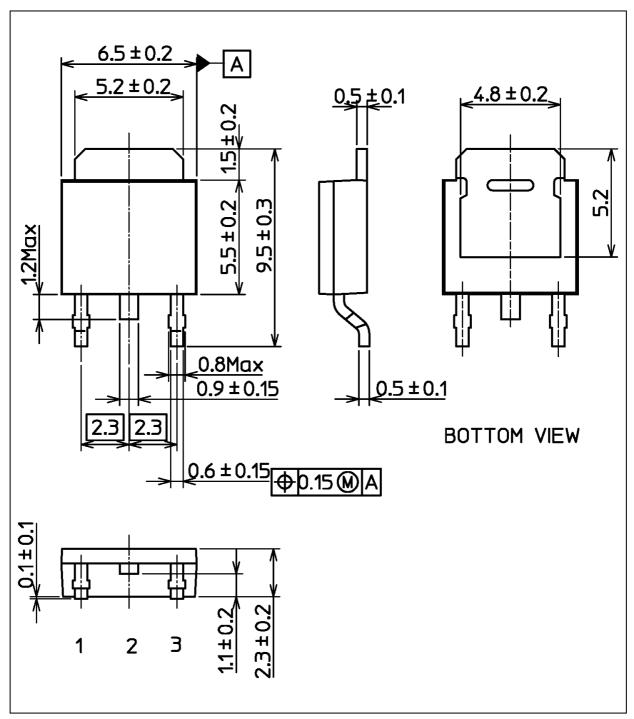




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

VDD





Weight: 0.36 g (typ.)

	Package Name(s)
TOSHIBA: 2-7M1A	
Nickname: DPAK+	

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